

## Application Data Sheet

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### **Inventor Information**

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Postal Address Line One	8-81, Yurigaokahigashi
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Citizenship Country:	Japan
Inventor Two Given Name:	Osamu
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### **Correspondence Information**

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### **Application Information**

Title Line One:	SEMICONDUCTOR LASER PACKAGE AND
Title Line Two:	FABRICATION METHOD THEREOF
Total Drawing Sheets:	6
Formal Drawings?:	Yes
Application Type:	Utility

Docket Number: 245402004300

### **Representative Information**

Representative Customer Number: 25226

### **Continuity Information**

This application is a:

> Application One:

Filing Date:

which is a:

>>Application Two:

Filing Date:

which is a:

>>>Application Three:

Filing Date:

### **Prior Foreign Applications**

Foreign Application One:	2001-025259
Filing Date:	February 1, 2001
Country:	Japan
Priority Claimed:	Yes